



# Product Change Notification

**Change Notification #:** 115730 - 00  
**Change Title:** Select Intel® Edison Compute Module, Intel® Edison Breakout Board, Intel® Edison Kit for Arduino\*, and Intel® Edison Breakout Board Kit Products, PCN 115730-00, Documentation, Transport Media, Label, Documentation, Transport Media, and Label update  
**Date of Publication:** August 08, 2017

## Key Characteristics of the Change:

Documentation, Transport Media, Label

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	August 21, 2017
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## Description of Change to the Customer:

NOTE: Changes below apply to Intel® Edison product inventory shipping into EU countries. No action is required of customers. All Intel Edison product inventory shipping from Intel as of Aug 21, 2017 will include the changes below and can be shipped into EU countries. Customers should be aware of the changes and take any necessary steps to insure no impact for their receiving and processing of the product in their manufacturing.

Relevant documentation can be found at:

<https://www.intel.com/content/www/us/en/support/boards-and-kits/000022230.html>

The Intel® Edison SKUs listed in the Products Affected table below will have the following changes:

1. Regulatory content and general format updates on paper insert for the European Union's Radio Equipment Directive (RED). The changes are shown in the photographs below.
2. Added pictogram for consumer set up instruction on paper insert
3. Added new Rev2 label on retail and bulk pack boxes to indicate revised paper insert. All supply shipped from Intel as of Aug 21, 2017 will include this label. As of June 12, 2017 customers are able to import only Rev2 product with revised paper insert into the EU.
4. Added new Rev2 label on Printed Circuit Board Assembly (PBA) to indicate revised paper insert to meet EU requirement.
  - a. All new inventory built will include labels on PBA. Existing inventory at Intel warehouse will not include labels on PBA. Customers can expect to receive mixed inventory until current inventory levels are depleted.
5. Outer boxes of current inventory will be sealed with double tape to indicate that it was opened by Intel warehouse in order to add Rev 2 label and new paper inserts to retail boxes. New paper insert supersedes existing paper insert in product.

Added new EU RED certification mark on paper insert



AT	BE	BG	CH	CY	CZ	DE	DK	EE
EL	ES	FL	FR	HR	HU	IE	IS	IT
LI	LT	LU	LV	MT	NL	NO	PL	PT
RO	SE	SI	SK	TR	UK			

This product is restricted to indoor operation when using the Wi-Fi radio between 5.15GHz and 5.25GHz.

New “Europe (CE declaration of conformity)” and translated by country

**European Union (CE declaration of conformity)**

Hereby, Intel declares that the radio equipment type Intel Edison module is in compliance with Radio Equipment Directive 2014/53/EU and RoHS Directive 2011/65/EU. The full text of the EU declaration of conformity is available at the following internet address:  
<http://www.Intel.com/edison/eudoc>

**Manufacturer:**

Intel Corporation, Attn: Corporate Quality,  
200 Mission College Blvd.,  
Santa Clara, CA 95054, USA  
ProductEcology@intel.com

**Importer into the EU:**

Intel Corporation (UK) Ltd.,  
Attn: Corporate Quality, Pipers Way, Swindon,  
Wiltshire SN3 1RJ, UK  
ProductEcology@intel.com

Edison Retail box (as is)



Edison Retail box (with Rev2 label)



Edison Bulk Pack box (as is)



Edison Bulk Pack box (with Rev2 label)



Edison Legacy Retail box (as is)



Edison Legacy Retail box (with Rev2 label)



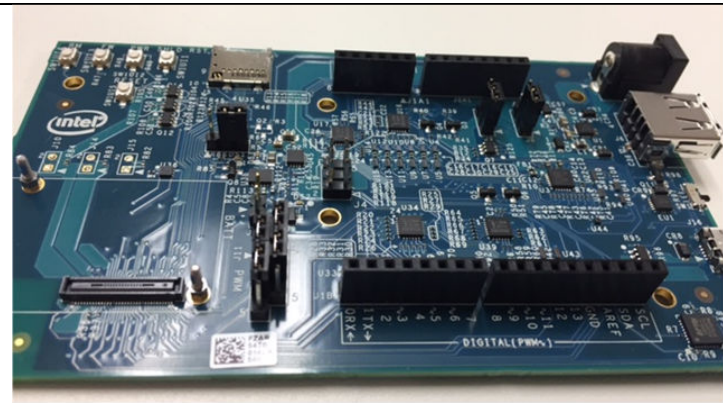
Edison PBA (as is)



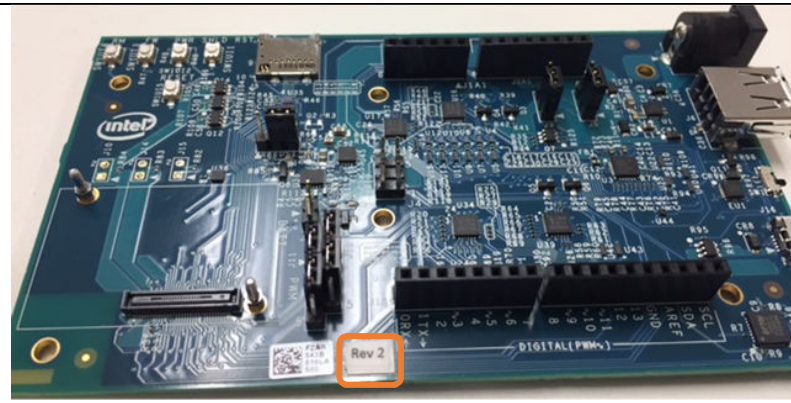
Edison PBA (with Rev2 label)



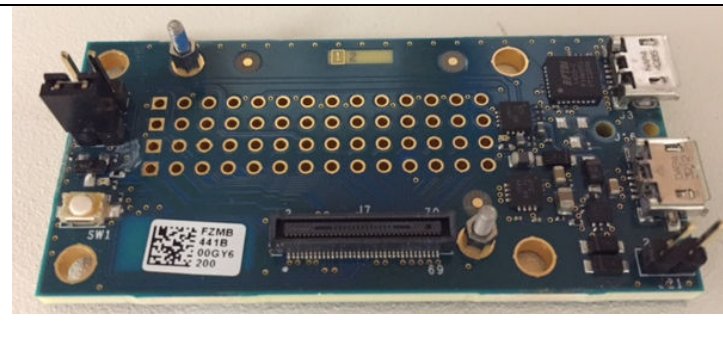
Arduino Expansion PBA (as is)



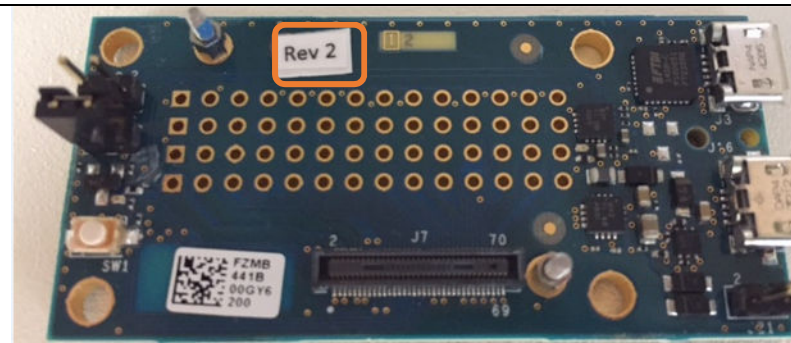
Arduino Expansion PBA (with Rev2 label)



Mini-Breakout PBA (as is)



Mini-Breakout PBA (with Rev2 label)



## Customer Impact of Change and Recommended Action:

This change has been thoroughly evaluated to ensure that there are no quality or reliability implications to our customers.

The paper insert and label changes do not affect the functionality of the product. No action is required of customers. All Intel Edison product inventory shipping from Intel as of Aug 21, 2017 will include the changes below and can be shipped into EU countries. Customers should be aware of the changes and take any necessary steps to insure no impact for their receiving and processing of the product in their manufacturing.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales representative if you have any further questions about these changes.

\* Other names and brands may be claimed as the property of others.

## Products Affected / Intel Ordering Codes:

Product Name	Product Code	MM#
Intel® Edison Compute Module (IoT, On-Board Antenna)	EDI2.SPON.AL.S	939910
Intel® Edison Compute Module (IoT, Off-Board Antenna)	EDI2.SPOF.AL.S	939957
Intel® Edison Compute Module (IoT Wearable, On-Board Antenna)	EDI2.LPON.AL.S	939962
Intel® Edison Kit for Arduino*	EDI2ARDUIN.AL.K	939976
Intel® Edison Breakout Board Kit	EDI2BB.AL.K	939977
Intel® Edison Compute Module (IoT, On-Board Antenna) 10 Pack	EDI2.SPON.AL.MP	939978
Intel® Edison Compute Module (IoT, On-Board Antenna) 10 Pack	EDI2.SPON.D.MP	952661
Intel® Edison Compute Module (IoT, Off-Board Antenna) 10 Pack	EDI2.SPOF.AL.MP	939983
Intel® Edison Compute Module (IoT Wearable, On-Board Antenna) 10 Pack	EDI2.LPON.AL.MP	939985
Intel® Edison Breakout Board	BB2.AL.B	939992
Intel® Edison Kit for Arduino*, Std Power, On-Board Antenna	EDI3ARDUIN.AL.K	939997
Intel® Edison Breakout Board Kit, Std Power, On-Board Antenna	EDI3BB.AL.K	939998

## PCN Revision History:

<b>Date of Revision:</b> August 8, 2017	<b>Revision Number:</b> 00	<b>Reason:</b> Originally Published PCN
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# Product Change Notification

## 115730 - 00

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The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

**Americas Contact:** [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

**Asia Pacific/PRC Contact:** [apacgccb@intel.com](mailto:apacgccb@intel.com)

**Europe Email:** [eccb@intel.com](mailto:eccb@intel.com)

**Japan Email:** [jccb.ijkk@intel.com](mailto:jccb.ijkk@intel.com)

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